A/D 581.40

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To the Honorable Commissioner of P 1018916	16 ne attached original documents or copy thereof.
1. Name of conveying party(ies): Oliver B. WRIGHT, David H. HURLEY and Osamu MATSUDA	2. Name and address of receiving party(ies): JAPAN SCIENCE AND TECHNOLOGY Name: CORPORATION Internal Address:
Additional names(s) of conveying party(ies)	
3. Nature of conveyance:	
XX Assignment ☐ Merger	Street Address: 1-8, Hon-cho 4-chome,
☐ Security Agreement ☐ Change of Name	Kawaguchi-shi, Saitama 332-0012,
☐ Other	City:JAPAN State:ZIP:
Execution Date: 6/3 & 6/8/01	Additional name(s) & address(es) attached? Yes XX No
If this document is being filed together with a new application, A. Patent Application No.(s) Additional numbers attach	B. Patent No.(s)
Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved: 1
Name: George A. Loud, Esquire	7. Total fee (37 CFR 3.41):\$ 40.00
Internal Address: LORUSSO & LOUD	Enclosed - Any excess or insufficiency should be credited or debited to deposit account
	☐ Authorized to be charged to deposit account
Street Address: 3137 Mount Vernon Avenue 08/03/2001 MNGUYEN 00000071 09890436	8. Deposit account number:
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9. Statement and signature. To the best of my knowledge and belief, the foregoing prioring of the original document. George A. Loud, Reg. No. 25,814 Name of Person Signing Total number of pages including cover	nation is true and correct and any attached copy is a true copy Signature Signature Date Date
Total number of nages including cover	sheet, attachments, and good PATENI

REEL: 012143 FRAME: 0978

ASSIGNMENT

WHEREAS, WE, Oliver B. WRIGHT, David H. HURLEY, and Osamu MATSUDA
of, respectively, 5-2, Sumikawa 4-jyo 1-chome, Minami-ku, Sapporo-shi,
Hokkaido 005-0004 Japan ; 610, Tetrault Road, Kalispell, Montana,
59901 USA ; 2-14, Sumikawa 2-jyo 2-chome, Minami-ku, Sapporo-shi,
Hokkaido 005-0002 Japan
ADDADAMUG BOD MEAGUDING
have invented certain improvements in "APPARATUS FOR MEASURING PHYSICAL PROPERTIES OF A SAMPLE
an application for Letters Patent of the United States; and
WHEREAS, JAPAN SCIENCE AND TECHNOLOGY CORPORATION
of 1-8, Hon-cho 4-chome, Kawaguchi-shi, Saitama 332-0012 Japan
is desirous of acquiring an interest therein;
NOW THEREFORE, for and in consideration of the sum of
One Dollar (\$1.00) and other good and valuable consideration, the
receipt of which is hereby acknowledged, we, Oliver B. WRIGHT, David H. HURLEY, and Osamu MATSUDA
by these presents do sell, assign and transfer unto said <u>JAPAN</u>
SCIENCE AND TECHNOLOGY CORPORATION its
successors, legal representatives, heirs and assigns, the full
and exclusive right, title and interest in the United States of
Amorica said application executed on the day of
June , 2001, (and we hereby authorize my attorneys,
authorized to prosecute said application, to here insert the
filing date and serial number of said application, when known:
Serial No Filed) to all Letters

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PATENT REEL: 012143 FRAME: 0979 Patents in the United States which may be granted on said application, to all divisions, continuations and continuations-in-part of said application, or reissues or extensions of said Letters Patent, all applications for Letters Patent and all Letters Patent therefor, to be held and enjoyed by JAPAN
SCIENCE AND TECHNOLOGY CORPORATION

and behoof and for its legal representatives, successors, heirs, and assigns, to the full end of the term for which said Letters Patent are granted and any extensions thereof, as fully and entirely as the same would have been held by us had this assignment and sale not been made; and for the same consideration, we hereby covenant and agree that, at the time of execution and delivery of this instrument, we hold good and full right and lawful authority to sell and convey the application for Letters Patent above mentioned in the manner herein set forth; and for the same consideration we hereby covenant and agree that JAPAN SCIENCE AND TECHNOLOGY we will, whenever counsel of CORPORATION the counsel of its successors, legal representatives, heirs or assigns, shall advise that any proceeding in connection with said application for Letters Patent, or any proceeding in connection with Letters Patent in the United States, including interference proceedings, is lawful and desirable, or that any division, continuation or continuation-in-part of any application for Letters Patent, or any reissue or extension of any Letters Patent to be obtained thereon, is lawful and desirable, sign all papers and documents, take all lawful oaths, and do all acts necessary

or required to be done for	the procurement, maintenance,
enforcement and defense of	said Letters Patent, without charge t
	representatives, heirs and assigns, bu JAPAN SCIENCE AND TECHNOLOGY
at the cost and expense of	CORPORATION its
successors, legal represent	atives, heirs and assigns; and we
hereby request the Commissi JAPAN SCIENCE AND	oner of Patents to issue said Letters
Datant to CORROBATION	, , , , , , , , , , , , , , , , , , , ,

Oliver B. WRIGHT

date

David H. HURLEY

6/8/0/ date

Osamu MATSUDA

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RECORDED: 07/31/2001